



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) Qualified to AEC-Q101 Standards for High Reliability

Case Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish - Matte Tin Annealed over Copper Leadframe.

UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020 Terminals Connections: See Diagram

Solderable per MIL-STD-202, Method 208 @3

Weight: 0.013 grams (Approximate)

**Features and Benefits** 

Low On-Resistance Low Input Capacitance Fast Switching Speed Low Input/Output Leakage ESD Protected Gate

**Mechanical Data** 

Case: TSOT26

#### **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D MAX</sub> T <sub>A</sub> = +25°С
01		0.45Ω @ V <sub>GS</sub> = 4.5V	
Q1 N-Channel	25V	0.60Ω @ V <sub>GS</sub> = 2.7V	0.68A
it onamo		0.73Ω @ V <sub>GS</sub> = 1.8V	
00		1.1Ω @ V <sub>GS</sub> = -4.5V	
Q2 P-Channel	-25V	1.5Ω @ V <sub>GS</sub> = -2.7V	-0.46A
· enamor		2.2Ω @ V <sub>GS</sub> = -1.8V	

# Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

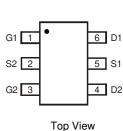
# **Applications**

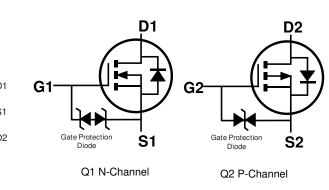
- Backlighting
- DC-DC Converters
- Power Management Functions

# ESD PROTECTED



Top View





## Ordering Information (Note 4)

Part Number	Case	Packaging
DMC3730UVT-7	TSOT26	3000 / Tape & Reel
DMC3730UVT-13	TSOT26	10,000 / Tape & Reel

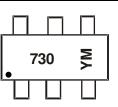
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



 $\begin{array}{l} 730 = \mbox{Product Type Marking Code} \\ YM = \mbox{Date Code Marking} \\ Y \mbox{or } \overline{Y} = \mbox{Year (ex: } F = 2018) \\ M = \mbox{Month (ex: } 9 = \mbox{September)} \end{array}$ 

#### Date Code Key

2410 0000 110	· <b>j</b>											
Year	2017	2018	20	019	2020	2021	1	2022	2023	20	24	2025
Code	E	F		G	Η			J	K	L	-	М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	25	-25	V		
Gate-Source Voltage	V <sub>GSS</sub>	±8	±8	V		
Continuous Drain Current (Note 6) N-Channel: V <sub>GS</sub> = 4.5V P-Channel: V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C	۱ <sub>D</sub>	0.68	-0.46	А
Maximum Continuous Body Diode Forward Curre	Is	0.3	-0.3	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	IDM	3	-2.5	А		

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	180	°C/W
Total Power Dissipation (Note 6)		PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	140	°C/W
Thermal Resistance, Junction to Case (Note 6)		R <sub>0JC</sub>	60	-C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	С°

# Electrical Characteristics N-CHANNEL – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	25	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	-	-	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.45	0.7	1.1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
		-	0.28	0.45		$V_{GS} = 4.5V, I_D = 0.5A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	0.33	0.60	Ω	$V_{GS} = 2.7V, I_D = 0.25A$	
		-	0.39	0.73		$V_{GS} = 1.8V, I_D = 0.1A$	
Diode Forward Voltage	V <sub>SD</sub>	-	0.75	1.2	V	$V_{GS} = 0V, I_{S} = 0.5A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	-	50	-	pF		
Output Capacitance	Coss	-	28	-	pF	−V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, −f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	-	9	-	pF	1 = 1.00012	
Gate Resistance	Rg	-	64	-	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	-	1.64	-	nC		
Gate-Source Charge	Q <sub>gs</sub>	-	0.38	-	nC	$V_{DS} = 5V, I_D = 0.5A,$	
Gate-Drain Charge	Q <sub>gd</sub>	-	0.45	-	nC	$V_{GS} = 4.5V$	
Turn-On Delay Time	t <sub>D(ON)</sub>	-	3	-	ns		
Turn-On Rise Time	t <sub>R</sub>	-	8	-	ns	$V_{GS} = 4.5V, V_{DS} = 6V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	-	17	-	ns	$R_g = 50\Omega, I_D = 0.5A$	
Turn-Off Fall Time	tF	-	13	-	ns		



# Electrical Characteristics P-CHANNEL – Q2 (@TA = +25°C, unless otherwise specified.)

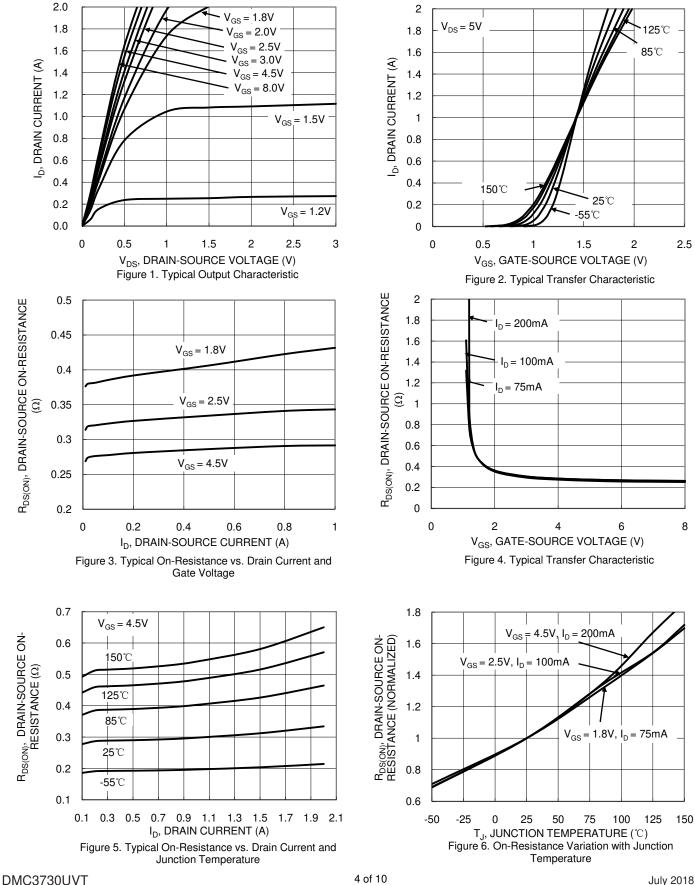
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-25	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	-	-	-1.0	μA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.5	-0.8	-1.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
		-	0.65	1.1		$V_{GS} = -4.5V, I_D = -0.5A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	0.80	1.5	Ω	$V_{GS} = -2.7V, I_D = -0.25A$	
		-	1.0	2.2		$V_{GS} = -1.8V, I_{D} = -0.1A$	
Diode Forward Voltage	V <sub>SD</sub>	-	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -0.5A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	-	63	-	pF		
Output Capacitance	Coss	-	34	-	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	10	-	pF		
Gate Resistance	Rg	-	178	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	-	1.1	-	nC		
Gate-Source Charge	Q <sub>gs</sub>	-	0.32	-	nC	V <sub>DS</sub> = -5V, I <sub>D</sub> = -0.25A , V <sub>GS</sub> = -4.5V	
Gate-Drain Charge	Q <sub>gd</sub>	-	0.25	-	nC	$V_{GS} = -4.5V$	
Turn-On Delay Time	t <sub>D(ON)</sub>	-	7	-	ns		
Turn-On Rise Time	t <sub>R</sub>	-	9	-	ns	$V_{GS} = -4.5V, V_{DS} = -6V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	-	55	-	ns	$R_g = 50\Omega, I_D = -0.5A$	
Turn-Off Fall Time	tF	-	35	-	ns		

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.



## **Typical Characteristics - N-CHANNEL**

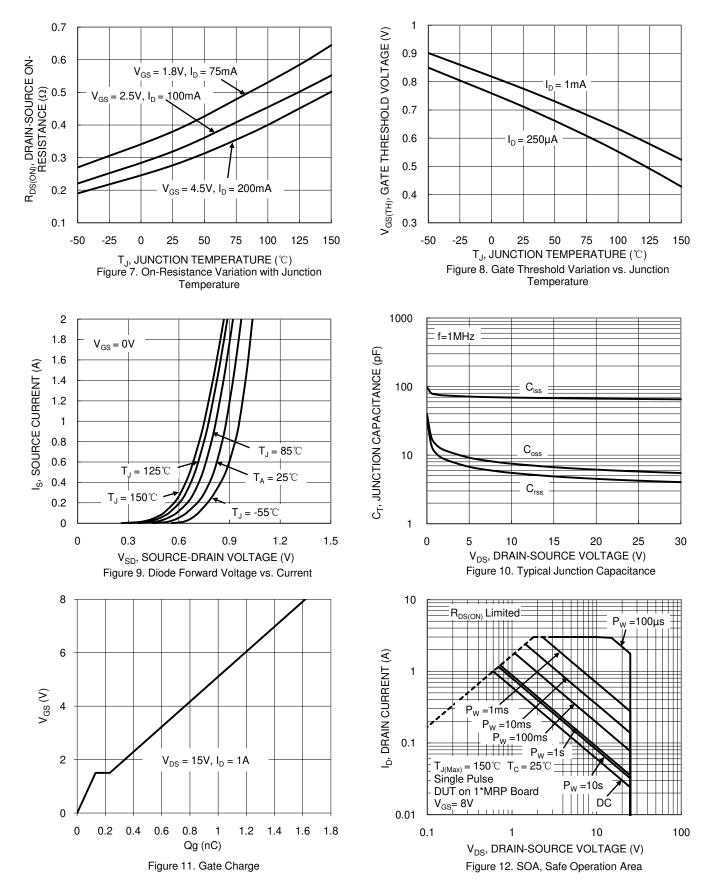


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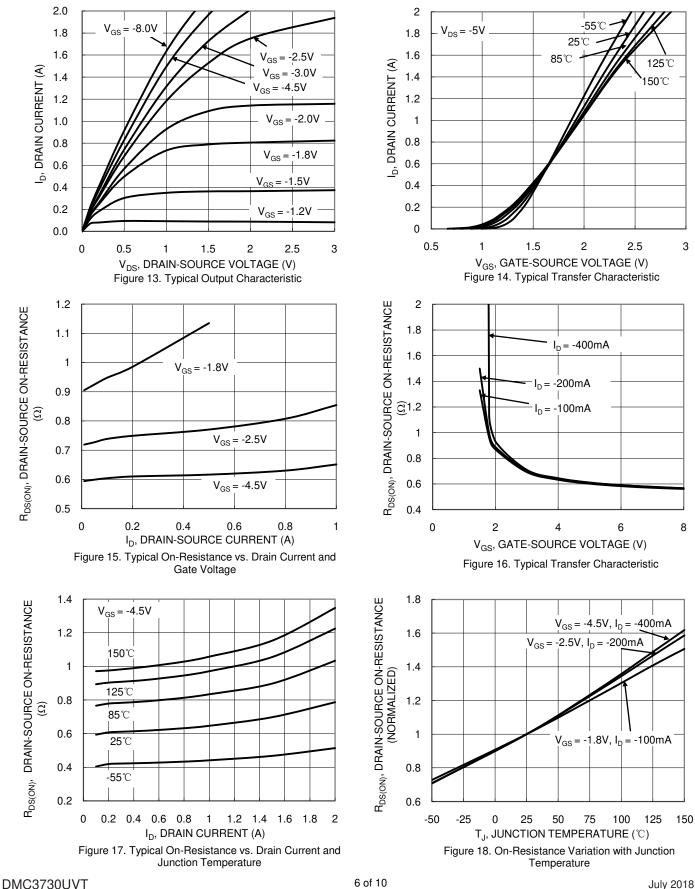
## Typical Characteristics - N-CHANNEL (Cont.)



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## **Typical Characteristics - P-CHANNEL**

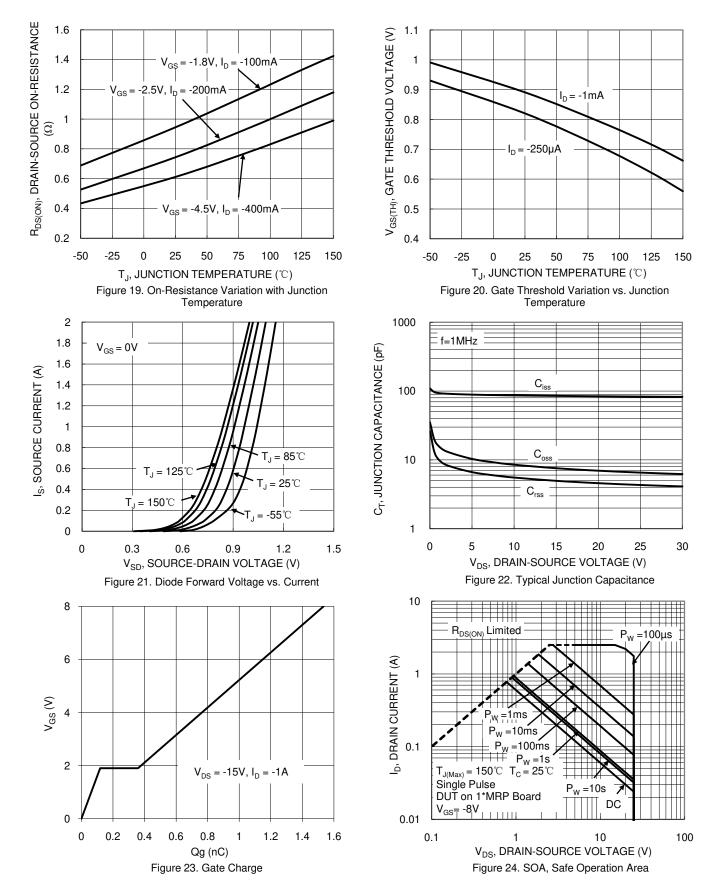


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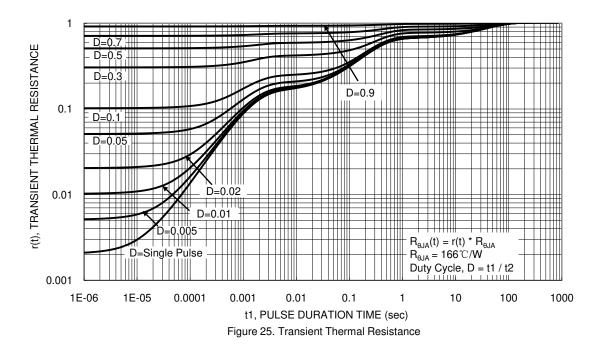


## Typical Characteristics - P-CHANNEL (Cont.)



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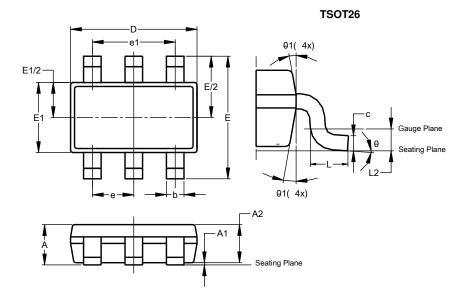






# **Package Outline Dimensions**

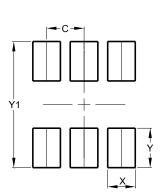
Please see http://www.diodes.com/package-outlines.html for the latest version.



	TSOT26								
Dim	Min	Max	Тур						
Α	-	1.00	-						
A1	0.010	0.100	-						
A2	0.840	0.900	-						
D	2.800	3.000	2.900						
E	2	.800 BS	С						
E1	1.500	1.700	1.600						
b	0.300	0.450	-						
С	0.120	0.200	-						
е	0	0.950 BSC							
e1	1	.900 BS	С						
1	0.30	0.50	-						
L2	0	.250 BS	С						
θ	0°	8°	4°						
θ1	4°	12°	-						
A	II Dimen	sions in	mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199

TSOT26



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